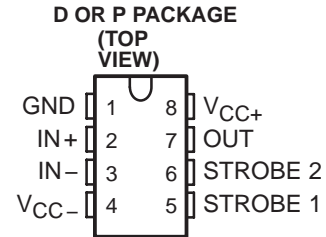


LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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- Fast Response Times
- Improved Gain and Accuracy
- Fanout to 10 Series 54/74 TTL Loads
- Strobe Capability
- Short-Circuit and Surge Protection
- Designed to Be Interchangeable With National Semiconductor LM306



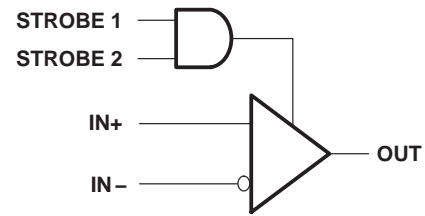
description

The LM306 is a high-speed voltage comparator with differential inputs, a low-impedance high-sink-current (100 mA) output, and two strobe inputs. This device detects low-level analog or digital signals and can drive digital logic or lamps and relays directly. Short-circuit protection and surge-current limiting is provided.

A low-level input at either strobe causes the output to remain high regardless of the differential input. When both strobe inputs are either open or at a high logic level, the output voltage is controlled by the differential input voltage. The circuit will operate with any negative supply voltage between -3 V and -12 V with little difference in performance.

The LM306 is characterized for operation from 0°C to 70°C.

functional block diagram



AVAILABLE OPTIONS

T _A	V _{IO} max at 25°C	PACKAGE	
		SMALL OUTLINE (D)	PLASTIC DIP (P)
0°C to 70°C	5 mV	LM306D	LM306P

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



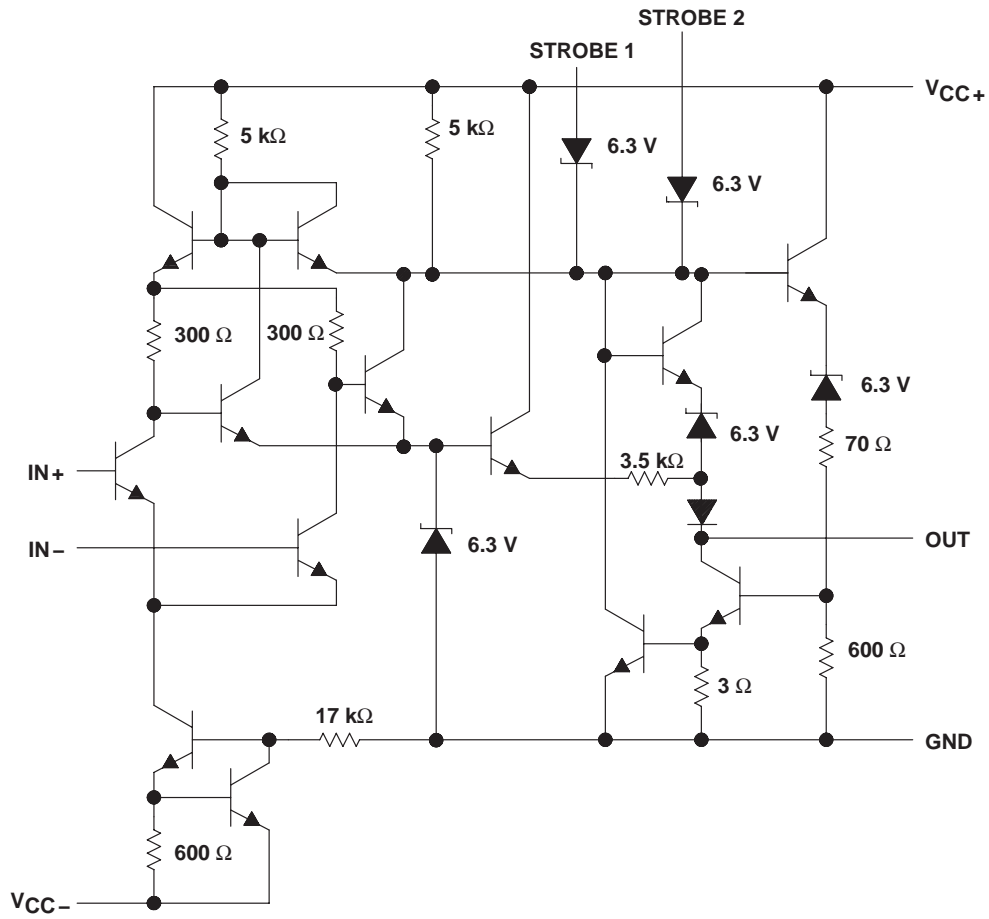
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LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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schematic



Resistor values are nominal.

LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC+} (see Note 1)	15 V
Supply voltage, V_{CC-} (see Note 1)	-15 V
Differential input voltage, V_{ID} (see Note 2)	± 5 V
Input voltage, V_I (either input, see Notes 1 and 3)	± 7 V
Strobe voltage range (see Note 1)	0 V to V_{CC+}
Output voltage, V_O (see Note 1)	24 V
Voltage from output to V_{CC-}	30 V
Duration of output short circuit to ground (see Note 4)	10 s
Continuous total dissipation	See Dissipation Rating Table
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages and the voltage from the output to V_{CC-} , are with respect to the network ground.
 2. Differential voltages are at $IN+$ with respect to $IN-$.
 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 7 V, whichever is less.
 4. The output may be shorted to ground or either power supply.

DISSIPATION RATING TABLE

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR	DERATE ABOVE T_A	$T_A = 70^\circ\text{C}$ POWER RATING
D	600 mW	5.8 mW/ $^\circ\text{C}$	46°C	464 mW
P	600 mW	8.0 mW/ $^\circ\text{C}$	75°C	600 mW



LM306

DIFFERENTIAL COMPARATOR WITH STROBES

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electrical characteristics at specified free-air temperature, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -3\text{ V}$ to -12 V (unless otherwise noted)

PARAMETER		TEST CONDITIONS†	T_A ‡	MIN	TYP	MAX	UNIT	
V_{IO}	Input offset voltage	$R_S \leq 200\ \Omega$	25°C		1.6§	5	mV	
			Full range			6.5		
αV_{IO}	Average temperature coefficient of input offset voltage	$R_S = 50\ \Omega$, See Note 5	Full range		5	20	$\mu\text{V}/^\circ\text{C}$	
I_{IO}	Input offset current	See Note 5	25°C		1.8	5	μA	
			MIN		1	7.5		
			MAX		0.5	5		
αI_{IO}	Average temperature coefficient of input offset current	See Note 5	MIN to 25°C		24	100	$\text{nA}/^\circ\text{C}$	
			25°C to MAX		15	50		
I_{IB}	Input bias current	$V_O = 0.5\text{ V}$ to 5 V	MIN to 25°C			40	μA	
			25°C to MAX		16	25		
$I_{IL(S)}$	Low-level strobe current	$V(\text{strobe}) = 0.4\text{ V}$	Full range		-1.7	-3.2	mA	
$V_{IH(S)}$	High-level strobe voltage		Full range	2.2			V	
$V_{IL(S)}$	Low-level strobe voltage		Full range			0.9	V	
V_{ICR}	Common-mode input voltage range	$V_{CC-} = -7\text{ V}$ to -12 V	Full range	± 5			V	
V_{ID}	Differential input voltage range		Full range	± 5			V	
A_{VD}	Large-signal differential voltage amplification	$V_O = 0.5\text{ V}$ to 5 V , No load	25°C		40		V/mV	
V_{OH}	High-level output voltage	$I_{OH} = -400\ \mu\text{A}$ $V_{ID} = 8\text{ mV}$	Full range	2.5		5.5	V	
V_{OL}	Low-level output voltage	$I_{OL} = 100\text{ mA}$ $V_{ID} = -7\text{ mV}$	25°C		0.8	2	V	
		$I_{OL} = 50\text{ mA}$ $V_{ID} = -7\text{ mV}$	Full range			1		
		$I_{OL} = 16\text{ mA}$ $V_{ID} = -8\text{ mV}$	Full range			0.4		
I_{OH}	High-level output voltage	$V_{OH} = 8\text{ V}$ to 24 V	$V_{ID} = 7\text{ mV}$	MIN to 25°C		0.02	2	μA
			$V_{ID} = 8\text{ mV}$	25°C to MAX			100	
I_{CC+}	Supply current from V_{CC+}	$V_{ID} = -5\text{ mV}$, No load	Full range		6.6	10	mA	
I_{CC-}	Supply current from V_{CC-}	No load	Full range		-1.9	-3.6	mA	

† Unless otherwise noted, all characteristics are measured with both strobes open.

‡ Full range is 0°C to 70°C. MIN is 0°C. MAX is 70°C.

§ This typical value is at $V_{CC+} = 12\text{ V}$, $V_{CC-} = -6\text{ V}$.

NOTE 5: The offset voltages and offset currents given are the maximum values required to drive the output down to the low range (V_{OL}) or up to the high range (V_{OH}). These parameters actually define an error band and take into account the worst-case effects of voltage gain and input impedance.

switching characteristics, $V_{CC+} = 12\text{ V}$, $V_{CC-} = -6\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS†	MIN	TYP	MAX	UNIT
Response time, low-to-high-level output	$R_L = 390\ \Omega$ to 5 V , $C_L = 15\text{ pF}$, See Note 6		28	40	ns

† All characteristics are measured with both strobes open.

NOTE 6: The response time specified is for a 100-mV input step with 5-mV overdrive and is the interval between the input step function and the instant when the output crosses 1.4 V.



TYPICAL CHARACTERISTICS

Table of Graphs

			FIGURE
I_{IB}	Input bias current	vs Free-air temperature	1
I_{IO}	Input offset current	vs Free-air temperature	2
V_{OH}	High-level output voltage	vs Free-air temperature	3
V_{OL}	Low-level output voltage	vs Free-air temperature	4
V_O	Output voltage	vs Differential input voltage	5
I_O	Output current	vs Differential input voltage	6
A_{VD}	Large-signal differential voltage amplification	vs Free-air temperature	7
I_{OS}	Short-circuit output current	vs Free-air temperature	8
	Output response	vs Time	9, 10
I_{CC+}	Positive supply current	vs Positive supply voltage	11
I_{CC-}	Negative supply current	vs Negative supply voltage	12
P_D	Total power dissipation	vs Free-air temperature	13

**INPUT OFFSET CURRENT
vs
FREE-AIR TEMPERATURE**

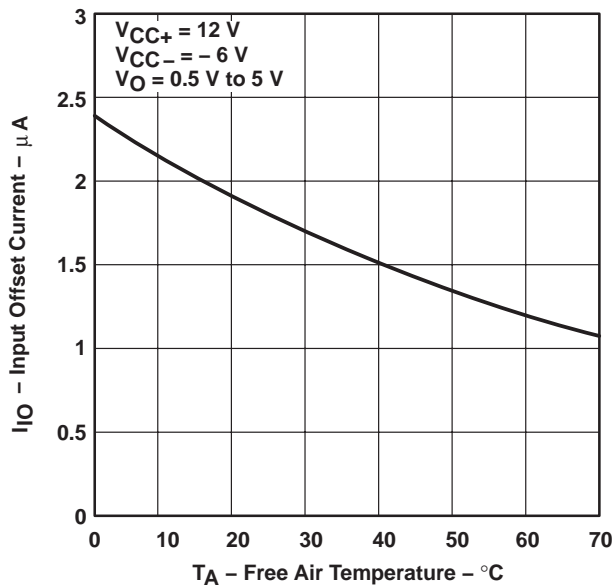


Figure 1

**INPUT BIAS CURRENT
vs
FREE-AIR TEMPERATURE**

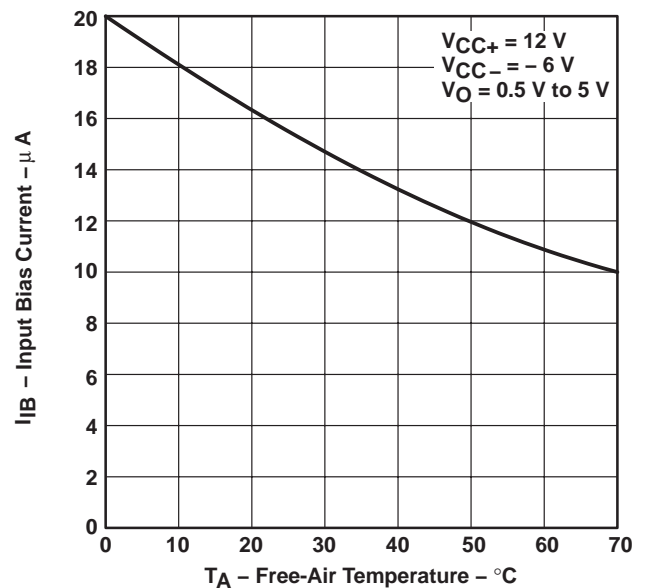


Figure 2

LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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TYPICAL CHARACTERISTICS

HIGH-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

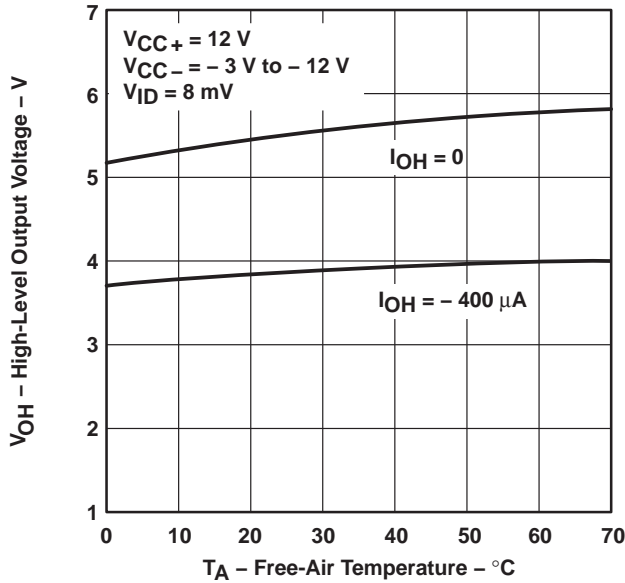


Figure 3

LOW-LEVEL OUTPUT VOLTAGE
vs
FREE-AIR TEMPERATURE

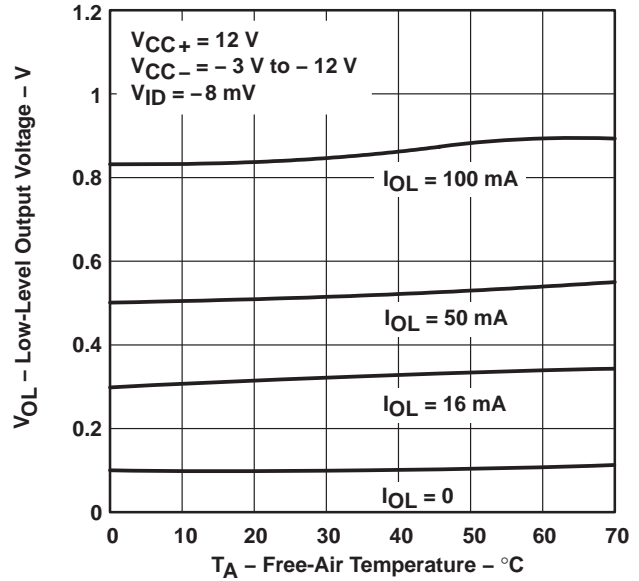


Figure 4

OUTPUT VOLTAGE
vs
DIFFERENTIAL INPUT VOLTAGE

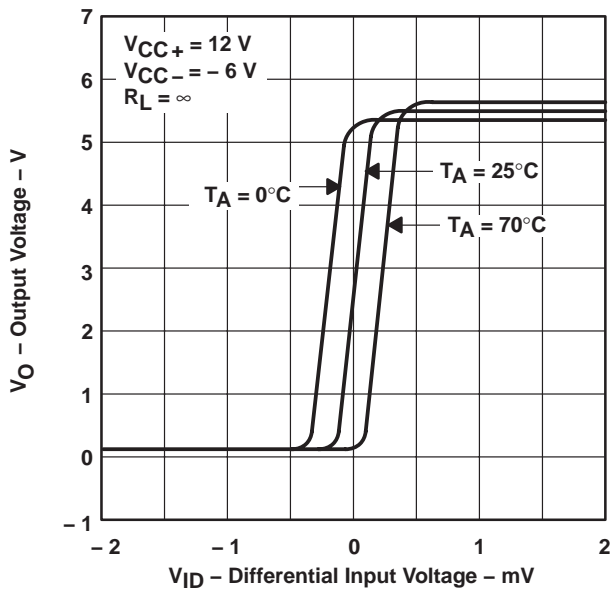


Figure 5

OUTPUT CURRENT
vs
DIFFERENTIAL INPUT VOLTAGE

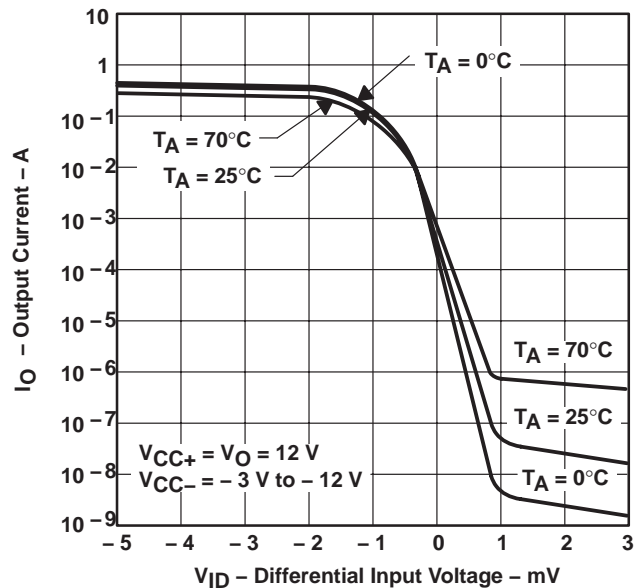


Figure 6



TYPICAL CHARACTERISTICS

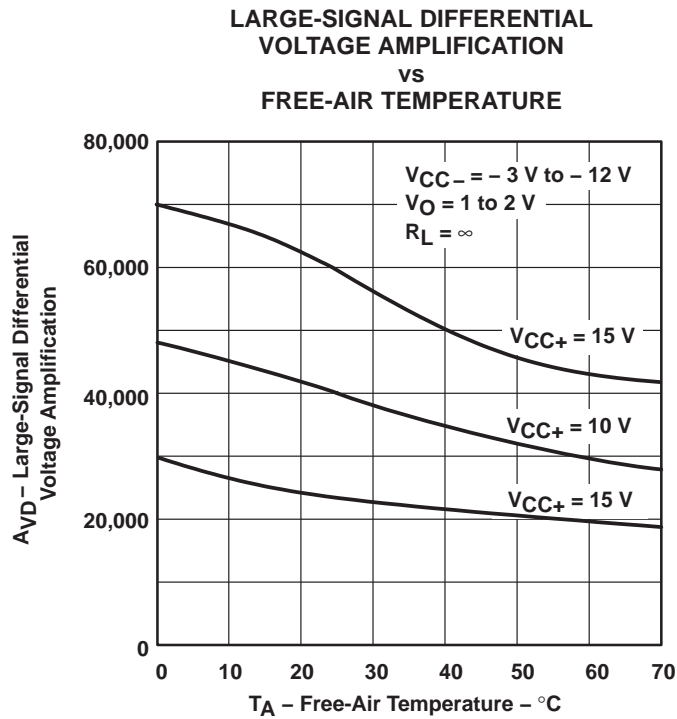
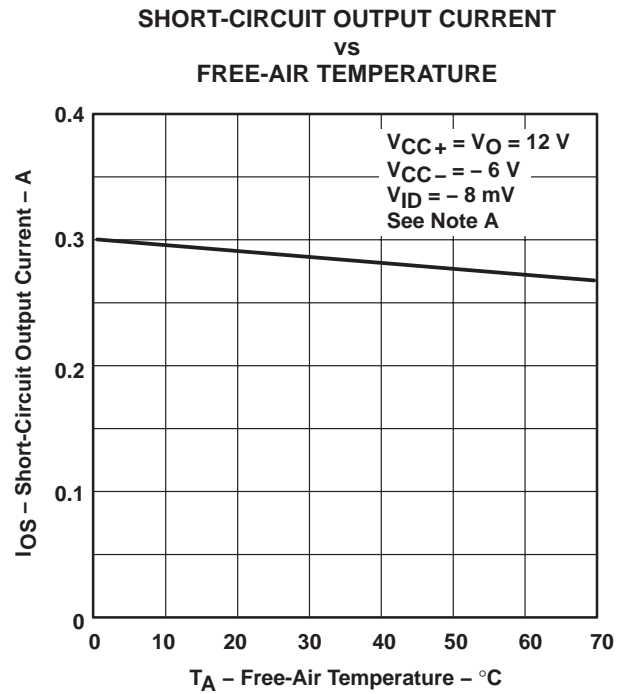


Figure 7



NOTE A: This parameter was measured using a single 5-ms pulse.

Figure 8

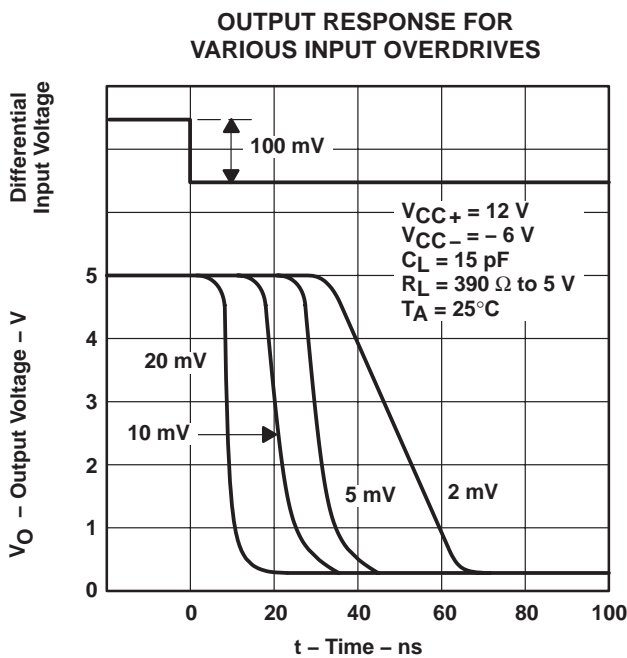


Figure 9

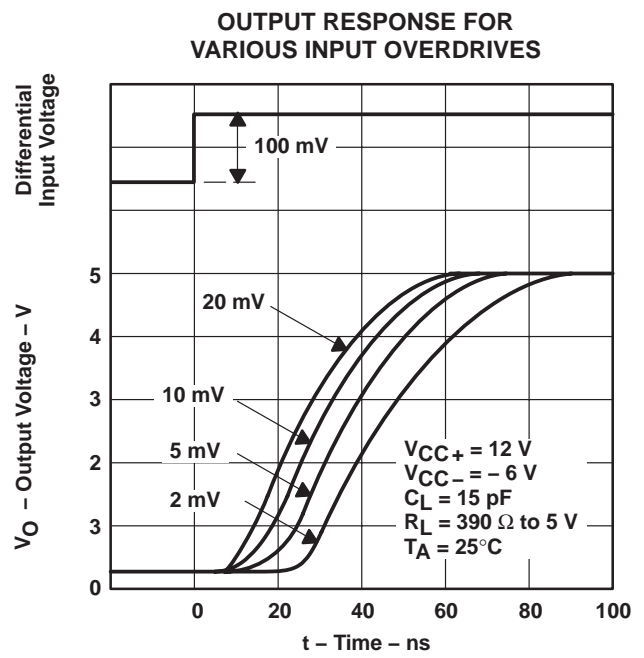


Figure 10

LM306 DIFFERENTIAL COMPARATOR WITH STROBES

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TYPICAL CHARACTERISTICS

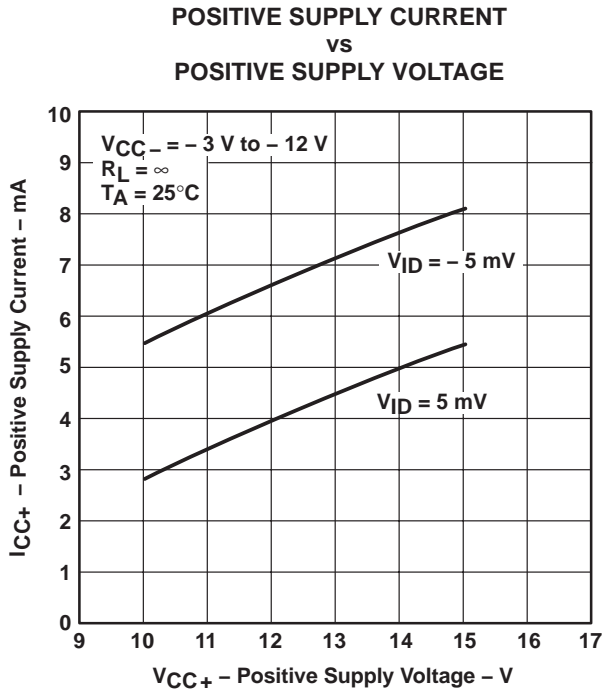


Figure 11

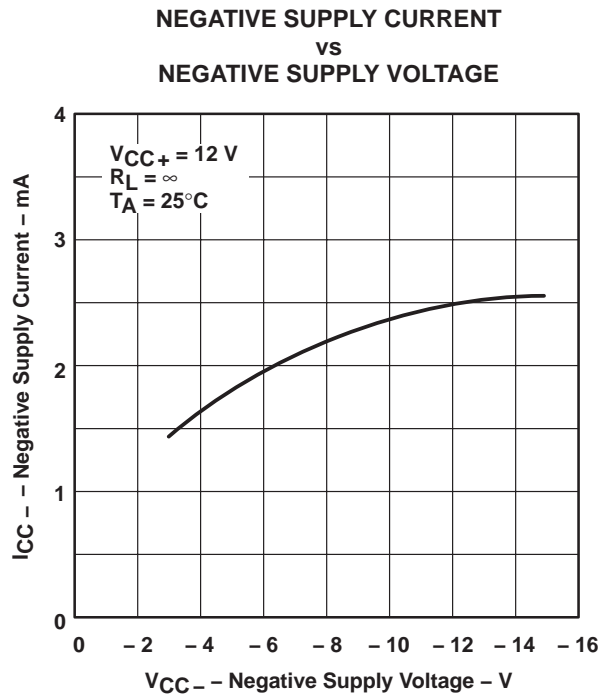


Figure 12

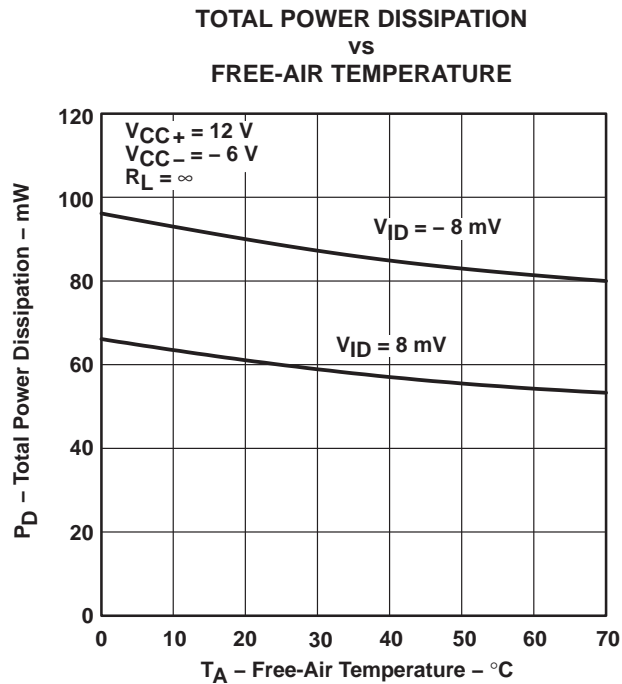


Figure 13



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM306D	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM306
LM306D.A	Active	Production	SOIC (D) 8	75 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	LM306
LM306P	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	LM306P
LM306P.A	Active	Production	PDIP (P) 8	50 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	LM306P

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
LM306D	D	SOIC	8	75	507	8	3940	4.32
LM306D.A	D	SOIC	8	75	507	8	3940	4.32
LM306P	P	PDIP	8	50	506	13.97	11230	4.32
LM306P.A	P	PDIP	8	50	506	13.97	11230	4.32



D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001 variation BA.

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